	YA OHI	M			
				Spec. No.: Date:	RMCH-K-HTS-0001 2017.4.21
		Data	she	et	
Title:		THICK FI NGULAR TY			•
Style:	RMCH1	6,20,32,35			
		AEC-Q2	00 qualified		
		RoHS COM	PLIANCE	ITEM	
		Halogen and			
	Relative hum The period of Product spec are subject to If you have a	: +5°C ~ +35°C idity: 25% ~ 75% f guarantee: Within 2 Soldera cification contained o change at any tir iny questions or a s necessary, pleas	bility shall be s d in this data me without no Purchasing \$	satisfied. sheet otice Specification	for any quality
		The second secon	釜 KAM/		株式會和 CTRIC CO., LT okkaido Research Cen

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Style

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1. Scope

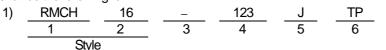
- 1.1 This data sheet covers the detail requirements for fixed thick film chip resistors; rectangular type & high power, style of RMCH16,20,32,35
- 1.2 Applicable documents

JIS C 5201–1: 2011, JIS C 5201–8: 2014, JIS C 5201–8–1: 2014 IEC60115–1: 2008, IEC60115–8: 2009, IEC60115–8–1: 2014 EIAJ RC–2134C–2010

2. Classification

(Example)

Type designation shall be the following form.



1 Fixed thick film chip resistors; rectangular type & high power

- 2 Rated dissipation and / or dimension
- 3 Temperature coefficient of resistance

K	±100×10 ⁻⁶ / °C
–(Dash)	Standard

4 Rated resistance

123	E24 Series, 3 digit,	Ex. 123> 12kΩ,
1000	E96 Series, 4 digit,	Ex. 1000>100Ω
		1022> 10.2kΩ

5 Tolerance on rated resistance

D	±0.5%
F	±1%
J	±5%

6 Packaging form

B Bulk (loose package)		
TP	TP Paper taping	
TE	Embossed taping	

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3. Rating

3.1 The ratings shall be in accordance with Table-1.

Table-1							
Style	Rated dissipation (W)	Temperature coefficient of resistance (10 ⁶ / °C)		Rated resistance range (Ω)	Preferred number series for resistors	Tolerance on rated resistance	
			±100	51~1M	E24, 96	D(±0.5%),F(±1%)	
RMCH16	0.25	Standard	+500200	1.0~49.9	L24, 90	D(±0.570),F(±170)	
RIVICITIO	0.25	Standard	±200	51~1M	E24	1(+50/)	
		Stariuaru	+500~-200	1.0~47	L24	J(±5%)	
	0.33		K	±100	51~1M	E24, 96	
RMCH20		Standard	+500~-200	1.0~49.9	⊏24, 90	D(±0.5%),F(±1%)	
RIVICHZU		Standard	±200	51~1M	E24	J(±5%)	
		Slanuaru	+500~-200	1.0~47			
		K	±100	51~1M	E24, 96		
RMCH32	0.5	Standard	+500~-200	1.0~49.9	⊏24, 90	D(±0.5%),F(±1%)	
RIVICHSZ	0.5 Standar	Stondard	±200	51~1M	F 04		
			Standa	Slandard	+500~-200	1.0~47	E24
	5 0.75	K	±100	51~1M	E24.06		
RMCH35			Standard	+500~-200	1.0~49.9	E24, 96	D(±0.5%),F(±1%)
CCUCIN			±200	51~1M	504	1(+50/)	
		Standard	+500~-200	1.0~47	E24	J(±5%)	

Style	Limiting element voltage (V)	Isolation voltage (V)	Category temperature range (°C)
RMCH16	150	150	
RMCH20			
RMCH32	200	500	-55~+155
RMCH35			

3.2 Climatic category 55/155/56

Lower category temperature	− 55 °C
Upper category temperature	+155 °C
Duration of the damp heat, steady state test	56days

3.3 Stability class

5%

Limits for change of resistance:

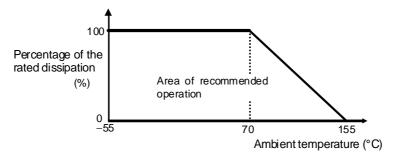
-for long-term tests	±(5%+0.1Ω)
-for short-term tests	±(1%+0.05Ω)

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3.4 Derating

The derated values of dissipation at temperature in excess of 70 °C shall be as indicated by the following curve.





3.5 Rated voltage

d. c. or a. c. r. m. s. voltage calculated from the square root of the product of the rated resistance and the rated dissipation.

$$E = \sqrt{P \cdot R}$$

E : Rated voltage (V) P : Rated dissipation (W) R : Rated resistance (Ω)

Limiting element voltage can only be applied to resistors when the resistance value is equal to or higher than the critical resistance value.

At high value of resistance, the rated voltage may not be applicable.

4. Packaging form

The standard packaging form shall be in accordance with Table-2.

Table-2

Symbol	Packaging form		Standard packaging quantity / units	Application
В	Bulk (loose package)		1,000 pcs.	RMCH16,20,32,35
TP	Paper taping 8mm width, 4mm pitches		5,000 pcs.	RMCH16,20,32
TE	Embossed taping	8mm width, 4mm pitches	4,000 pcs.	RMCH35

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5. Dimensions

5.1 The resistor shall be of the design and physical dimensions in accordance with Figure-2 and Table-3.

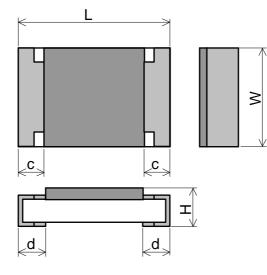


Figure-2

	Table-3				Unit : mm
Style	L	W	Н	С	d
RMCH16	1.6±0.1	0.8 ^{+0.15} -0.05	0.45±0.10	0.3 <u>+</u> 0.2	0.3 <u>±</u> 0.1
RMCH20	2.0±0.1	1.25±0.10	0.55±0.10	0.3 <u>+</u> 0.2	0.3 <u>+</u> 0.2
RMCH32	3.1±0.1	1.6±0.15	0.55±0.10	0.4 <u>+</u> 0.25	0.5 <u>+</u> 0.25
RMCH35	3.1 <u>±</u> 0.15	2.5±0.15	0.55 <u>±</u> 0.15	0.4 <u>+</u> 0.25	0.5 <u>+</u> 0.25

5.2 Net weight (Reference)

U (,
Style	Net weight(mg)
RMCH16	2
RMCH20	5
RMCH32	9
RMCH35	16

6. Marking

The nominal resistance shall be marked in 3 digits or 4 digits and marked on over coat side.

• E24 series: 3 digits, E96 series: 4 digits

In case of the resistance value that E96 overlaps with E24, It is marked by either.

The Rated resistance of RMCH16 should not be marked in 4 digits (E96).

Marking example	Contents	Application
123	$12 \times 10^3 \ [\Omega] \rightarrow 12 \ [k\Omega]$	RMCH16,20,32,35
2R2	2.2 [Ω]	Less than 10Ω of RMCH16,20,32,35
5623	$562 \times 10^{3} [\Omega] \rightarrow 562 [k\Omega]$	RMCH20,32,35
12R7	12.7 [Ω]	RMCH20,32,35

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7. Performance

7.1 The standard condition for tests shall be in accordance with Sub-clause 4.2, JIS C 5201-1:2011.

7.2 The performance shall be satisfied in Table-4.

	Table-4(1)				
No.	Test items	Condition of test (JIS C 5201–1)	Performance requirements As in 4.4.1 The marking shall be legible, as checked by visual examination.		
1	Visual examination	Sub–clause 4.4.1 Checked by visual examination.			
2	Dimension Resistance	Sub–clause 4.4.2 Sub–clause 4.5	As specified in Table–3 of this specification. As in 4.5.2 The resistance value shall correspond with the rated resistance taking into account the specified		
3	Voltage proof	Sub-clause 4.7 Method: 4.6.1.4 Test voltage: Alternating voltage with a peak value of 1.42 times the insulation voltage. Duration: 60 s ± 5 s Insulation resistance Test voltage: Insulation voltage Duration: 1 min.	tolerance. No breakdown or flash over $R \ge 1 \ G \ \Omega$		
4	Solderability	 Sub–clause 4.17 Without ageing Flux: The resistors shall be immersed in a non–activated soldering flux for 2s. Bath temperature: 235 °C ± 5 °C Immersion time: 2 s ± 0.5 s 	As in 4.17.4.5 The terminations shall be covered with a smooth and bright solder coating.		
5	Mounting Overload (in the mounted state) Solvent resistance of the marking	Sub-clause 4.31 Substrate material: Epoxide woven glass Sub-clause 4.13 The applied voltage shall be 2.5 times the rated voltage or twice the limiting element voltage, whichever is the less severe. Duration: 2 s Visual examination Resistance Sub-clause 4.30 Solvent: 2-propanol Solvent temperature: 23 °C \pm 5 °C Method 1 Rubbing material: cotton wool Without recovery	No visible damage ∆R ≤ ± (1%+0.05Ω) Legible marking		

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	Table-4(2)			
No	Test items	Condition of test (JIS C 5201–1)	Performance requirements	
6	Mounting Bound strength of the end face plating	Sub-clause 4.31 Substrate material: Epoxide woven glass Sub-clause 4.33 Bent value: 3 mm		
	Final measurements	Resistance Sub-clause 4.33.6 Visual examination	$\Delta R \le \pm (1\%+0.05\Omega)$ No visible damage	
7	Resistance to soldering heat Component solvent resistance	Sub-clause 4.18 Solder temperature: 260 °C ± 5 °C Immersion time: 10 s ± 0.5 s Visual examination Resistance Sub-clause 4.29 Solvent: 2-propanol	As in 4.18.3.4 No sign of damage such as cracks. $\Delta R \le \pm (1\%+0.05\Omega)$	
		Solvent temperature: 23 °C ± 5 °C Method 2 Recovery: 48 h Visual examination Resistance	No visible damage $\Delta R \leq \pm (1\%+0.05\Omega)$	
8	Mounting Adhesion	Sub-clause 4.31 Substrate material: Epoxide woven glass Sub-clause 4.32 Force: 5 N Duration: $10 \text{ s} \pm 1 \text{ s}$ Visual examination	No visible damage	
	Rapid change temperature	Sub-clause 4.19 Lower category temperature: -55 °C Upper category temperature: +155 °C Duration of exposure at each temperature: 30 min. Number of cycles: 5 cycles. Visual examination Resistance	No visible damage $\Delta R \le \pm (1\%+0.05\Omega)$	

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	Table-4(3)		
Test items	Condition of test (JIS C 5201–1)	Performance requirements	
Climatic sequence –Dry heat	Sub-clause 4.23 Sub-clause 4.23.2 Test temperature: +155 °C Duration: 16 h Sub-clause 4.23.3 Test method: 2		
–Damp heat, cycle (12+12hour cycle) First cycle	Test temperature: 55 °C [Severity(2)] Sub–clause 4.23.4 Test temperature –55 °C Duration: 2h		
-Cold	Sub-clause 4.23.6 Test method: 2 Test temperature: 55 °C		
–Damp heat, cycle (12+12hour cycle) Remaining cycle	[Severity (2)] Number of cycles: 5 cycles Sub-clause 4.23.7 The applied voltage shall be the rated voltage		
–D.C. load	the smaller. Duration: 1 min. Visual examination	No visible damage $\Delta R \leq \pm (5\%+0.1\Omega)$	
Mounting	Sub–clause 4.31 Substrate material: Epoxide woven glass		
Endurance at 70 °C	Sub-clause 4.25.1 Ambient temperature: 70 °C \pm 2 °C Duration: 1000 h The voltage shall be applied in cycles of 1.5 h on and 0.5 h off. The applied voltage shall be the rated voltage or the limiting element voltage whichever is the smaller. Examination at 48 h , 500 h and 1000 h:	No visible damage	
		$\Delta R \le \pm (5\% + 0.1\Omega)$	
Mounting Variation of resistance with temperature	Sub-clause 4.31 Substrate material: Epoxide woven glass Sub-clause 4.8 -55 °C / +20 °C	As in Table-1	
	Climatic sequence -Dry heat -Damp heat, cycle (12+12hour cycle) First cycle -Cold -Damp heat, cycle (12+12hour cycle) Remaining cycle -D.C. load Mounting Endurance at 70 °C Mounting Variation of resistance with	Test items Condition of test (JIS C 5201–1) Climatic sequence Dry heat Sub-clause 4.23 Sub-clause 4.23.2 Test temperature: +155 °C Duration: 16 h Sub-clause 4.23.3 Test method: 2 Test temperature: 55 °C (Severity(2)] Damp heat, cycle (12+12hour cycle) Sub-clause 4.23.4 Test temperature: 55 °C Duration: 2h Sub-clause 4.23.6 Test method: 2 Test temperature: 55 °C (Severity(2)] Cold Sub-clause 4.23.6 Test method: 2 Test temperature: 55 °C (Severity(2)] Damp heat, cycle (12+12hour cycle) Remaining cycle Number of cycles: 5 cycles Sub-clause 4.23.7 The applied voltage shall be the rated voltage or the limiting element voltage whichever is the smaller. -D.C. load Sub-clause 4.31 Sub-clause 4.31 Substrate material: Epoxide woven glass Mounting Sub-clause 4.25.1 Ambient temperature: 70 °C ± 2 °C Duration: 1000 h The voltage shall be the rated voltage or the limiting element voltage whichever is the smaller. Endurance at 70 °C Sub-clause 4.25.1 Ambient temperature: 70 °C ± 2 °C Duration: 1000 h The voltage shall be the rated voltage or the limiting element voltage whichever is the smaller. Examination at 48 h , 500 h and 1000 h: Visual examination Resistance Test amination Resistance Mounting Sub-clause 4.31 Sub-clause 4.31 Sub-clause 4.31 Sub-clause 4.31 Sub-clause 4.31	

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	Table-4(4)			
No	Test items	Condition of test (JIS C 5201–1)	Performance requirements	
12 Mounting Damp heat, steady state		Sub-clause 4.31 Substrate material: Epoxide woven glass Sub-clause 4.24 Ambient temperature: 40 °C ± 2 °C Relative humidity : 93 $^{+2}_{-3}$ % a) 1st group: without voltage applied. b) 2nd group: The d. c. voltage shall be applied continuously. The voltage shall be accordance with Sub-clause 4.24.2.1 b). without polarizing voltage [4.24.2.1, c)] Visual examination	No visible damage Legible marking	
		Resistance	ΔR ≤ ± (5%+0.1Ω)	
13	Dimensions (detail) Mounting	Sub-clause 4.4.3 Sub-clause 4.31	As in Table-3	
	Endurance at upper category temperature Substrate material: Epoxide woven glass Sub-clause 4.25.3 Ambient temperature:155 °C ± 2 °C Duration: 1000 h Examination at 48 h, 500 h and 1000 h: Visual examination Resistance		No visible damage $\Delta R \leq \pm (5\%+0.1\Omega)$	

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8. Taping

8.1 Applicable documents JIS C 0806-3: 2014, EIAJ ET-7200C: 2010

8.2 Taping dimensions

8.2.1 Paper taping (8mm width, 4mm pitches)

Taping dimensions shall be in accordance with Figure-3 and Table-5.

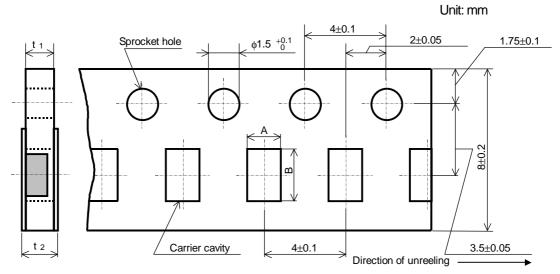
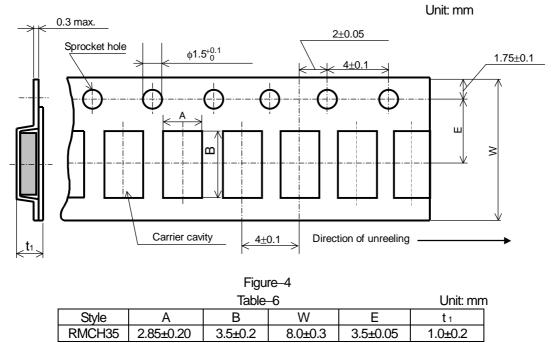


Figure-3

. . .

Table-5			Unit: mm	
Style	A	В	t 1	t 2
RMCH16	1.15 ± 0.15	1.9 ± 0.2	0.6 ± 0.1	0.8max.
RMCH20	1.65±0.15	2.5±0.2	0.0.01	1.0max.
RMCH32	2.00±0.15	3.6±0.2	0.8±0.1	

8.2.2 Embossed taping dimensions shall be in accordance with Figure-4 and Table-6.



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KAMAYA OHM

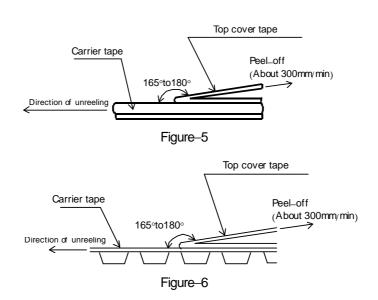
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- 1). The cover tapes shall not cover the sprocket holes.
- 2). Tapes in adjacent layers shall not stick together in the packing.
- 3). Components shall not stick to the carrier tape or to the cover tape.
- 4). Pitch tolerance over any 10 pitches ±0.2mm.
- 5). The peel strength of the top cover tape shall be with in 0.1N to 0.5N on the test method as shown in the following RMCH16,20,32: Figure–5, RMCH35: Figure–6.
- 6). When the tape is bent with the minimum radius for 25 mm, the tape shall not be damaged and the components shall maintain their position and orientation in the tape.
- 7). In no case shall there be two or more consecutive components missing.

The maximum number of missing components shall be one or 0.1%, whichever is greater.

8). The resistors shall be faced to upward at the over coating side in the carrier cavity.

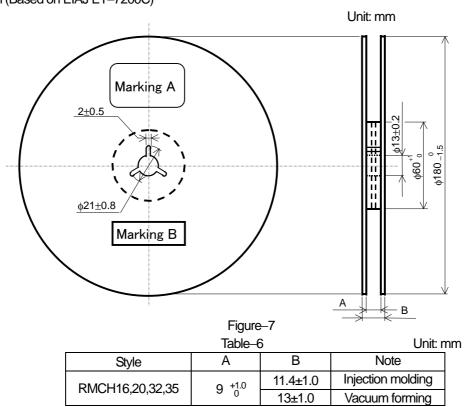


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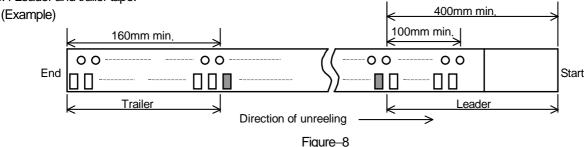
8.3 Reel dimension

Reel dimensions shall be in accordance with the following Figure-7 and Table-6. Plastic reel (Based on EIAJ ET-7200C)



Note: Marking label shall be marked on a place of Marking A or two place of marking A and B.

8.4 Leader and trailer tape.



9. Marking on package

The label of a minimum package shall be legibly marked with follows.

9.1 Marking A

(1) Classification

(Style, Temperature coefficient of resistance, Rated resistance, Tolerance on rated resistance, Packaging form) (2) Quantity (3) Lot number (4) Manufacturer's name or trade mark (5) Others 9.2 Marking B (KAMAYA Control label)

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